WHAT IS CLAIMED IS:

មានសុខសម្រាស់ ស្រុកស្រួង ខេត្ត សមាជាប

1995年,1996年1月2日,1997年

- 1. A method for manufacturing a polycrystalline semiconductor layer, comprising the step of laser annealing an amorphous semiconductor layer in a low degree vacuum atmosphere.
- 2. The method defined in Claim 1, wherein said annealing is performed under a pressure between about 1.3 x 10³ Pa and about 1.3 Pa.
- 3. The method defined in Claim 2, wherein said annealing is performed in an annealing atmosphere containing an inert gas.
- 4. The method defined in Claim 3, wherein said inert gas includes a gas selected from the group consisting of nitrogen, hydrogen, argon, and neon.
- 5. The method defined in Claim 1, wherein said annealing is performed in an annealing atmosphere containing an inert gas.
- 6. The method defined in Claim 5, wherein said inert gas includes a gas selected from the group consisting of

nitrogen, hydrogen, argon, and neon.

7. A method of manufacturing a thin-film transistor, comprising the steps of:

forming an amorphous silicon layer on a substrate; disposing said substrate inside an annealing chamber;

annealing chamber; and

irradiating focused laser light onto the amorphous silicon layer overlying said substrate through a chamber window built in said annealing chamber to anneal and polycrystallize said amorphous silicon, whereby a polycrystalline silicon layer is formed as an active layer of said thin-film transistor.

- 8. The method defined in Claim 7, wherein said annealing is performed under a pressure between about 1.3 \times 10³ Pa and about 1.3 Pa.
- 9. The method defined in Claim 7, wherein said annealing is performed in an annealing atmosphere containing an inert gas.
- 25 10. The method defined in Claim 9, wherein said inert

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gas includes a gas selected from the group consisting of nitrogen, hydrogen, argon, and neon.

11. A laser annealing apparatus, wherein focused laser light is irradiated through a chamber window onto an object to be processed placed inside a annealing chamber, comprising:

an introducer for introducing an inert gas into said annealing chamber during annealing;

a pump for reducing the pressure in said annealing chamber; and

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a pressure controller for controlling the pressure in said annealing chamber to maintain a pressure between about 1.3 x 10³ Pa and about 1.3 Pa.